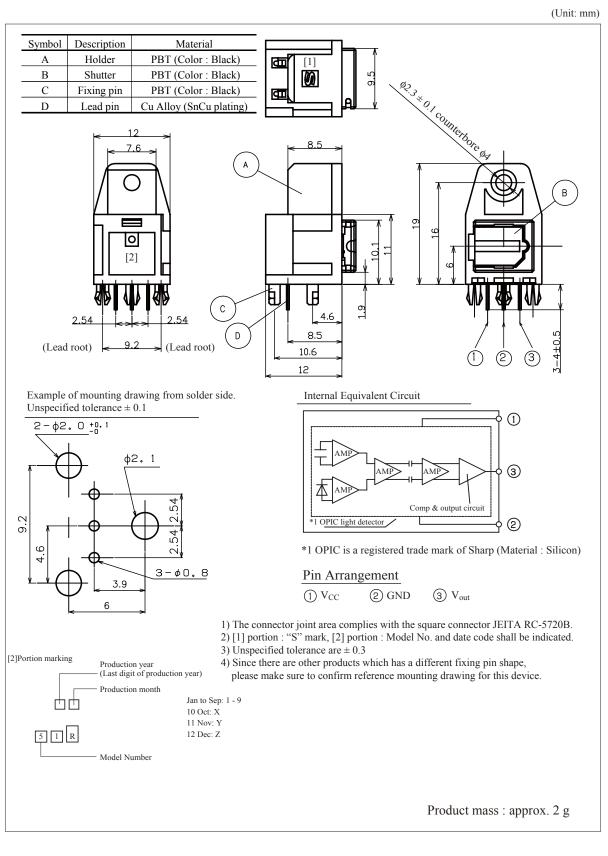
SHARP

Outline Dimensions



Parameter	Symbol	Rating	Unit	Remark	
Supply voltage	V _{CC}	-0.5 to +7.0	V		
Operating temperature	T _{opr}	-20 to +70	°C		
Storage temperature	T _{stg}	-30 to +80	°C		
Soldering temperature *1	T _{sol}	260	°C	6 s or less/time up to 2 times.	
		380	°C	4 s or less/time up to 1 time. Soldering by hand at each terminal. *2	
Output current	I _{oH}	2	mA	Source current	
	I _{oL}	10	mA	Sink current	

■Absolute Maximum Ratings

*1 Solder at a position more than 1.6 mm away from the base of the lead terminal. Reflow is not available.

*2 Do not contact top of soldering iron to lead terminal directly.

Recommended Operating Conditions

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Remark
Supply voltage	V _{CC}	4.75	5.0	5.25	V	
Operating transfer rate	Т	0.1	-	13.2	Mb/s	Notes (1), (2)
Receiver input optical power level	P _C	-24.0	-	-14.5	dBm	Peak optical output

Notes

(1) This operating transfer rate shall be a specification when NRZ, duty 50 % of continuous "0101..." signal is transferred.

(2) The output (H/L Level) of this product are not fixed constantly when it receivers the modulating light

(including DC light, no input light) less than 0.1 Mb/s.

Electro-optical Characteristics

Symbol Conditions TYP MAX. Parameter MIN Unit Peak sensitivity wavelength λ_p 700 _ _ nm Measurement method refer to Fig. 1 Supply current $I_{CC} \\$ _ 25 mA _ High level output voltage V_{oH} 2.7 3.5 V -Low level output voltage Vo_L 0.35 0.5 V -Rise time 15 tr -23 ns Measurement method refer to Fig. 2, 3 Fall time $t_{\rm f}$ 7 15 _ ns $L \rightarrow H$ delay time 180 -_ t_{pLH} ns $H \rightarrow L$ delay time 180 t_{pHL} -_ ns Pulse width distortion Δt_w -20 +20_ ns Measurement method refer to Fig. 4, 5, 1 15 ns PC = -14.5 dBmJitter Δt_i Measurement method refer to Fig. 4, 5, _ _ 15 ns PC = -24 dBm

 $(T_a = 25 \circ C, V_{CC} = 5 V)$